ASSOCIATION CONNECTINIELEGTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					fg Informa	ition		
Supplier Inform												<u> </u>			
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
onsemi											2024-04-20				
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Represe	ntative*		Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stewa	ırds	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requeste	Requester Item Number Mfr Iter		m Number Mfr Item Name				Effective Date Version Manufacturing S		Manufacturing Site		Weight*	UOM	Unit Type		
		SZMMBZ33VAWT1 ZEN SC70 DU		ZEN SC70 DUAI	AL 33V		2024-04-20			CN1		5.0	mg	Each	
Ianufacturing	Proccess Informatio	n													
Terminal	Terminal Plating / Grid Array Material Terminal Base Allo			Alloy	J-STD-020 MSL Rating Peak Process I				Temperatu	re Max Time at Peak	Temperat	ure Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed		C	CU Alloy 1			260	260 C		30	secon	ds 3				
omments															
vel 1 - maximum t	ime at peak temperature	during sold	dering is 10-3	0 seconds											
or more informatio	on regarding material cor	nposition p	olease refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct omponents, the declaration shall encompass all such components. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg
Lead Frame	2.08	mg	В	Nickel (Ni)	7440-02-0		0.7966	mg
			Supplier	Iron (Fe)	7439-89-6		1.1003	mg
			Supplier	Copper (Cu)	7440-50-8		0.183	mg
Mold Compound-Black	3.7	mg	Supplier	Boron zinc hydroxide oxide	138265-88-0		0.111	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0185	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs-triazine-triol	37640-57-6		0.111	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.96	mg
			Supplier	Carbon Black (C)	1333-86-4		0.037	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.296	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.1665	mg
Plating	0.11	mg	Supplier	Tin (Sn)	7440-31-5		0.11	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg